



LC709006A

CMOS IC

I/O-Expander for Microcontroller

ON Semiconductor®

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Overview

The LC709006A is a peripheral IC dedicated for expanding the capability of the microcontroller (MCU) I/O ports. It interfaces with the microcontroller through synchronous serial communication. Communication with the extended I/O ports is accomplished through 24-bit parallel I/O. The extended port features include the capabilities to specify the I/O direction on a bit basis, to specify the output type (CMOS or N-channel open drain), and to specify the I/O voltage level on a port basis according to the power level of the peripheral equipment. These features make the LC709006A to be used in a wide variety of applications.

Features

- 4-/5-wire synchronous serial transmission and reception, and 24-bit parallel I/O
- Wide operating voltage range (2.0V to 6.0V)
- Multifunction I/O ports
 - I/O direction specification: Bit units
 - CMOS or Nch-OD output type specification: Bit units
 - Output voltage adjustment: Port (8 bits) units
- Output current: 12mA max. (capable of driving a green LED directly)
- Data transmission and reception: Can control reception of input data and transmission of output data in parallel.
- Cascaded configuration: Ports can be expanded in units of 24 bits \times n (n is the number of LSI chips).
- Packaging from: MFP36SDJ (375mil): lead-free type

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Specifications

Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$, $V_{SS} = V_{SS\ P0} = V_{SS\ P2} = 0\text{V}$

Parameter	Symbol	Pin/Remarks	Conditions	$V_{DD}[\text{V}]$	Ratings			Unit
					min	typ	max	
Maximum supply voltage	$V_{DD\ max}$	$V_{DD}, V_{DD\ P0}, V_{DD\ P1}, V_{DD\ P2}$	$V_{DD}=V_{DD\ P0}=V_{DD\ P1}=V_{DD\ P2}$		-0.3		+7.0	V
Input voltage	V_I	$\overline{RES}, \overline{CS}, \overline{DIN}, \overline{CLK}$			-0.3		$V_{DD}+0.3$	
Output voltage	V_O	DOUT			-0.3		$V_{DD}+0.3$	
Input/output voltage	$V_{IO(1)}$	Port 0			-0.3		$V_{DD\ P0}+0.3$	
	$V_{IO(2)}$	Port 1			-0.3		$V_{DD\ P1}+0.3$	
	$V_{IO(3)}$	Port 2			-0.3		$V_{DD\ P2}+0.3$	
High level output current								
Peak output current	IOPH(1)	Ports 0 to 2	CMOS output selected Per 1 applicable pin		-7			mA
	IOPH(2)	DOUT			-13			
Mean output current (Note 1)	IOMH(1)	Ports 0 to 2	CMOS output selected Per 1 applicable pin		-3			
	IOMH(2)	DOUT			-6			
Total output current	$\Sigma IOP0H$	Port 0	Total of all applicable pins		-32			
	$\Sigma IOP1H$	Port 1	Total of all applicable pins		-32			
	$\Sigma IOP2H$	Port 2	Total of all applicable pins		-32			
	$\Sigma IOAH$	DOUT, ports 0 to 1	Total of all applicable pins		-105			
Low level output current								
Peak output current	IOPL(1)	Ports 0 to 2	Per 1 applicable pin				16	mA
	IOPL(2)	DOUT					13	
Mean output current (Note 1)	IOML(1)	ports 0 to 2	Per 1 applicable pin				7	
	IOML(2)	DOUT					6	
Total output current	$\Sigma IOP0L$	Port 0	Total of all applicable pins				32	
	$\Sigma IOP1L$	Port 1	Total of all applicable pins				32	
	$\Sigma IOP2L$	Port 2	Total of all applicable pins				32	
	$\Sigma IOAL$	DOUT, ports 0 to 2	Total of all applicable pins				105	
Power dissipation	$P_d\ max$	MFP36SDJ	Ta=-30 to +70°C				330	mW
			Ta=-40 to +85°C				250	
Operating temperature	Topr				-40		85	°C
Storage temperature	Tstg				-55		125	

Note 1: The mean output current is a mean value measured over 100ms.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

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Allowable Operating Conditions at $T_a = -40$ to $+85^\circ\text{C}$, $V_{SS} = V_{SS P0} = V_{SS P2} = 0\text{V}$

Parameter	Symbol	Pin/Remarks	Conditions	Specification (Note 3)			Unit
				$V_{DD}[\text{V}]$	min	typ	
Operating supply voltage	$V_{DD}(1)$	V_{DD}			2.0		6.0
	$V_{DD}(2)$	$V_{DD P0}$	Supply voltage must be within V_{DD} (1)'s specification.		$V_{DD}-3.0$		V_{DD}
	$V_{DD}(3)$	$V_{DD P1}, V_{DD P2}$	Supply voltage must be within V_{DD} (1)'s specification.		V_{DD}		$V_{DD}+3.0$
High level input voltage	$V_{IH}(1)$	DIN, ports 0 to 2		4.5 to 6.0	$0.3V_{DD}+0.7$		$V_{DD P_x}$
	$V_{IH}(2)$	DIN, ports 0 to 2		2.0 to 6.0	$0.3V_{DD}+0.7$		$V_{DD P_x}$
	$V_{IH}(3)$	$\overline{RES}, \overline{CS}, \overline{CLK}$		4.5 to 6.0	$0.4V_{DD}+0.7$		V_{DD}
	$V_{IH}(4)$	$\overline{RES}, \overline{CS}, \overline{CLK}$		2.0 to 6.0	$0.4V_{DD}+0.7$		V_{DD}
Low level input voltage	$V_{IL}(1)$	DIN, ports 0 to 2		4.5 to 6.0	V_{SS}		$0.2V_{DD}+0.1$
	$V_{IL}(2)$	DIN, ports 0 to 2		2.0 to 6.0	V_{SS}		$0.2V_{DD}+0.1$
	$V_{IL}(3)$	$\overline{RES}, \overline{CS}, \overline{CLK}$		4.5 to 6.0	V_{SS}		$0.1V_{DD}+0.2$
	$V_{IL}(4)$	$\overline{RES}, \overline{CS}, \overline{CLK}$		2.0 to 6.0	V_{SS}		$0.1V_{DD}+0.2$

Note 3: $V_{DD P_x}$ denote the power supply pin ($V_{DD P0}, V_{DD P1}, V_{DD P2}$) for port pins.

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Electrical Characteristics at $T_a = -40$ to $+85^\circ\text{C}$, $V_{SS} = V_{SSP} = V_{SSP2} = 0\text{V}$

Parameter	Symbol	Pin/Remarks	Conditions	(Note 3)		Specification			Unit
				$V_{DD}[\text{V}]$	$V_{DDPx}[\text{V}]$	min	typ	max	
High level input current	I_{IH}	$\overline{RES}, \overline{CS}, \overline{CLK}$, Ports 0 to 2	$V_{IN}=V_{DD}$ (including output Tr. off leakage current)	2.0 to 6.0				10	μA
Lower level input current	I_{IL}	$\overline{RES}, \overline{CS}, \overline{CLK}$, Ports 0 to 2	$V_{IN}=V_{SS}$ (including output Tr. off leakage current)	2.0 to 6.0			-10		
High level output voltage	$V_{OH}(1)$	Ports 0	$I_{OH}=2\text{mA}$	2.0 to 6.0	4.5 to 6.0	$V_{DDPx-0.5}$			V
	$V_{OH}(2)$		$I_{OH}=5\text{mA}$	2.0 to 6.0	4.5 to 6.0	$V_{DDPx-1.0}$			
	$V_{OH}(3)$		$I_{OH}=-1\text{mA}$	2.0 to 6.0	2.0 to 6.0	$V_{DDPx-0.5}$			
	$V_{OH}(4)$	Ports 1	$I_{OH}=2\text{mA}$	2.0 to 6.0	4.5 to 6.0	$V_{DDPx-0.5}$			
	$V_{OH}(5)$		$I_{OH}=5\text{mA}$	2.0 to 6.0	4.5 to 6.0	$V_{DDPx-1.0}$			
	$V_{OH}(6)$		$I_{OH}=-1\text{mA}$	2.0 to 6.0	2.0 to 6.0	$V_{DDPx-0.5}$			
	$V_{OH}(7)$	DOUT	$I_{OH}=-5\text{mA}$	4.5 to 6.0		$V_{DDPx-0.5}$			
	$V_{OH}(8)$		$I_{OH}=-10\text{mA}$	4.5 to 6.0		$V_{DDPx-1.0}$			
	$V_{OH}(9)$		$I_{OH}=-2\text{mA}$	2.0 to 6.0		$V_{DDPx-0.5}$			
Lower level output voltage	$V_{OL}(1)$	Ports 0	$I_{OL}=5\text{mA}$	4.5 to 6.0	2.0 to 6.0			0.4	V
	$V_{OL}(2)$		$I_{OL}=12\text{mA}$	4.5 to 6.0	2.0 to 6.0			1	
	$V_{OL}(3)$		$I_{OL}=2\text{mA}$	2.0 to 6.0	2.0 to 6.0			0.4	
	$V_{OL}(4)$	Ports 1,2	$I_{OL}=5\text{mA}$	4.5 to 6.0	4.5 to 6.0			0.4	
	$V_{OL}(5)$		$I_{OL}=12\text{mA}$	4.5 to 6.0	4.5 to 6.0			1	
	$V_{OL}(6)$		$I_{OL}=2\text{mA}$	2.0 to 6.0	2.0 to 6.0			0.4	
	$V_{OL}(7)$	DOUT	$I_{OL}=5\text{mA}$	4.5 to 6.0				0.4	
	$V_{OL}(8)$		$I_{OL}=10\text{mA}$	4.5 to 6.0				1	
	$V_{OL}(9)$		$I_{OL}=2\text{mA}$	2.0 to 6.0				0.4	
Pull-up resistance	$R_{pu}(1)$	\overline{CS}	$V_{OH}=V_{SS}$	4.5 to 6.0		100	230	650	$\text{k}\Omega$
Voltage hysteresis	V_{HIS}	$\overline{RES}, \overline{CS}, \overline{CLK}$		2.0 to 6.0			$0.1V_{DD}$		V
Consumption current (operation stopped)	$IDDSP$	$V_{DD}=V_{DDP0}=V_{DDP1}=V_{DDP2}$	$\overline{RES}=\overline{CS}=V_{DD}$ $\overline{CLK}=\overline{DIN}=V_{DD}$ or V_{SS} $DOUT=\text{open}$ $P0$ to $P2=\text{open}$ or V_{DD} or V_{SS} (Note 2)	2.0 to 6.0				20	μA
Pin capacity	CP	All pins	Other than test pin $V_{IN}=V_{SS}$ $f=1\text{MHz}$ $T_a=25^\circ\text{C}$	2.0 to 6.0			10		pF

Note 2: The consumption current does not include the current flowing into the port's output transistor.

Note 3: V_{DDPx} denote the power supply pin ($V_{DDP0}, V_{DDP1}, V_{DDP2}$) for port pins.

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Switching I/O Characteristics at $T_a = -40$ to $+85^\circ C$, $V_{DD} = V_{DDP0} = V_{DDP1} = V_{DDP2}$, $V_{SS} = V_{SSP0} = V_{SSP1} = V_{SSP2}$, $V_{SS} = 0V$

Parameter	Symbol	Pin/Remarks	Conditions	Specification			Unit
				$V_{DD}[V]$	min	typ	
Clock setup time	TsCLK	\overline{CS} , \overline{CLK}	• Specified with respect to falling edge of \overline{CS} . • See Fig. 9.	2.0 to 6.0	100		
Chip select low level setup time	TsICS	\overline{CS} , \overline{CLK}	• Specified with respect to falling edge of \overline{CS} . • See Fig. 9.	2.0 to 6.0	100		
Chip select low level hold time	ThICS	\overline{CS} , \overline{CLK}	• Specified with respect to falling edge of \overline{CS} . • See Fig. 9.	2.0 to 6.0	100		
Clock hold time	ThCLK	\overline{CS} , \overline{CLK}	• Specified with respect to falling edge of \overline{CS} . • See Fig. 9.	2.0 to 6.0	200		
Clock low level pulse width	TwICLK	\overline{CLK}	• See Fig. 9.	4.5 to 6.0	250		
				2.7 to 6.0	500		
				2.0 to 6.0	1000		
Clock high level pulse width	TwhCLK	\overline{CLK}	• See Fig. 9.	4.5 to 6.0	250		
				2.7 to 6.0	500		
				2.0 to 6.0	1000		
Chip select high level setup time	TshCS	\overline{CS} , \overline{RES}	• See Fig. 9.	2.0 to 6.0	200		
Chip select high level hold time	ThhCS	\overline{CS} , \overline{RES}	• See Fig. 9.	2.0 to 6.0	100		
Chip select low level pulse width	TwIcs	\overline{CS} , \overline{RES}	• See Fig. 9.	2.0 to 6.0	200		
Reset low level pulse width	TwIRES	\overline{CS} , \overline{RES}	• See Fig. 9.	2.0 to 6.0	150		
Data setup time	TsDIN	DIN	• Specified with respect to falling edge of \overline{CLK} . • See Fig. 9.	4.5 to 6.0	30		
				2.0 to 6.0	50		
Data hold time	ThDIN	DIN	• Specified with respect to falling edge of \overline{CLK} . • See Fig. 9.	4.5 to 6.0	50		
				2.7 to 6.0	150		
				2.0 to 6.0	300		
Serial data output delay time (Note 4)	TdD0UT	DOUT	• Specified with respect to falling edge of \overline{CLK} . • See Fig. 9.	4.5 to 6.0			200
				2.7 to 6.0			400
				2.0 to 6.0			800
Port data output delay time	TdPOUT	Port 0 to 2	• Specified with respect to rising edge of \overline{CS} . • See Fig. 9.	4.5 to 6.0			200
				2.7 to 6.0			400
				2.0 to 6.0			800
Port data input setup time	TsPIN	Port 0 to 2	• Specified with respect to rising edge of \overline{CLK} . • See Fig. 9.	4.5 to 6.0	30		
				2.0 to 6.0	50		
Port data input hold time	ThPIN	Port 0 to 2	• Specified with respect to rising edge of \overline{CLK} . • See Fig. 9.	4.5 to 6.0	50		
				2.7 to 6.0	150		
				2.0 to 6.0	300		

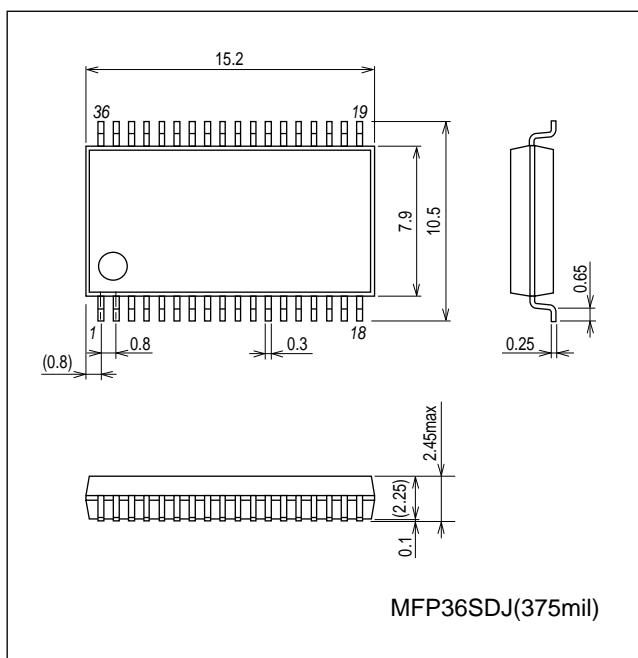
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Note 4: The input data of P00 will be out from DOUT terminal at the first negative edge of \overline{CLK} signal. Because of this, Serial data output delay time of the first clock will be the time measured from the negative edge of the \overline{CLK} or the time at the input data (P00) is settled.

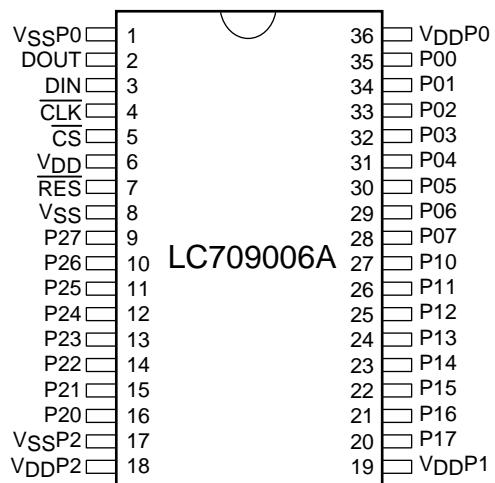
Package Dimensions

unit : mm (typ)

3263

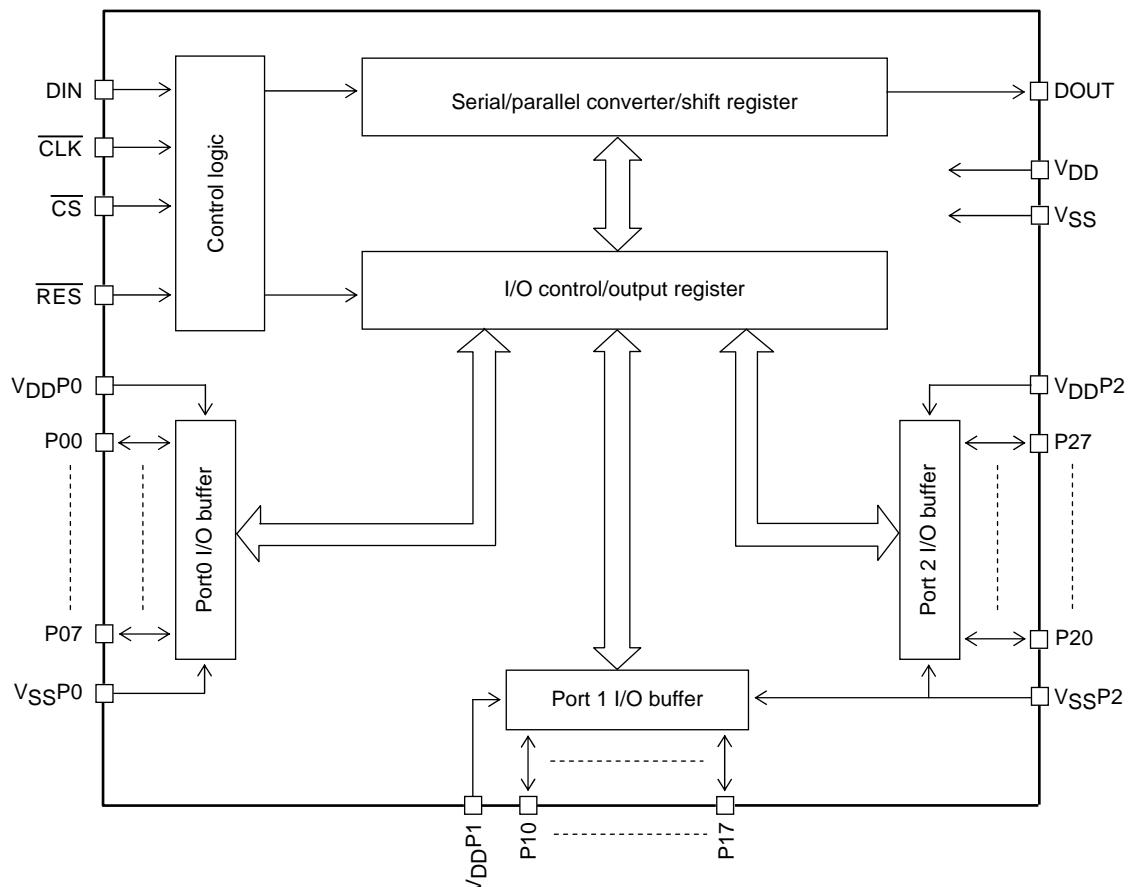


Pin Assignment



Top view

Block Diagram



Pin Description

Pin Name	I/O	Description	I/O Type	Reset Time
V _{SS} V _{SSP0} V _{SSP2}	-	<ul style="list-style-type: none"> - power supply pin V_{SS} is the power supply pin for blocks other than I/O ports (P00 to P27). V_{SSP0} is the power supply pin for port pins P00 to P07. V_{SSP2} is the power supply pin for port pins P10 to P17 and P20 to P27. 		
V _{DD} V _{DDP0} V _{DDP1} V _{DDP2}	-	<ul style="list-style-type: none"> + power supply pin V_{DD} is the power supply pin for blocks other than I/O ports (P00 to P27). V_{DDP0} is the power supply pin for port pins P00 to P07. V_{DDP1} is the power supply pin for port pins P10 to P17. V_{DDP2} is the power supply pin for port pins P20 to P27. <p>(Notes)</p> <ul style="list-style-type: none"> V_{DDP0} must not be set higher than V_{DD} (V_{DDP0}≤V_{DD}). V_{DDP1} must not be set lower than V_{DD} (V_{DDP1}≥V_{DD}). V_{DDP2} must not be set lower than V_{DD} (V_{DDP2}≥V_{DD}). 		
Port 0 P00 to P07	I/O	<ul style="list-style-type: none"> 8-bit I/O port I/O specifiable in 1 bit units. CMOS/Nch-open drain specifiable in 1 bit units. Output voltage variable in 1 port units according to V_{DDP0} voltage. 	Output: CMOS/Nch-OD Input: TTL	Hi-Z
Port 1 P10 to P17	I/O	<ul style="list-style-type: none"> 8-bit I/O port I/O specifiable in 1 bit units. CMOS/Nch-open drain specifiable in 1 bit units. Output voltage variable in 1 port units according to V_{DDP1} voltage. 	Output: CMOS/Nch-OD Input: TTL	Hi-Z
Port 2 P20 to P27	I/O	<ul style="list-style-type: none"> 8-bit I/O port I/O specifiable in 1 bit units. CMOS/Nch-open drain specifiable in 1 bit units. Output voltage variable in 1 port units according to V_{DDP2} voltage. 	Output: CMOS/Nch-OD Input: TTL	Hi-Z

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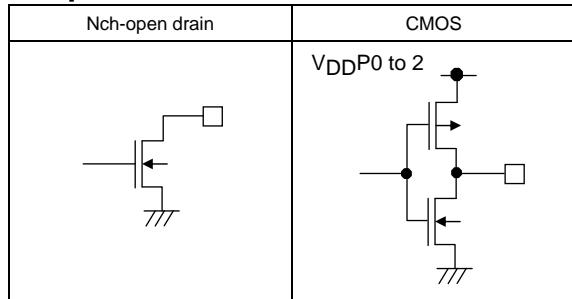
Pin Name	I/O	Description	I/O Type	Reset Time
DIN	I	• Serial data input pin	Input: TTL	
DOUT	O	• Serial data output pin	Output: CMOS	High
CLK	I	• Serial clock input pin • Port data is placed on DOUT on the falling edge of this clock. • The data from DIN is latched on the negative-to-positive transition of this clock.	Input: TTL Schmidt	
CS	I	• Chip select input pin • Setting this pin to the low level enables serial data to be input or output.	Input: TTL Schmidt	
RES	I	• Device's system reset input pin • Setting this pin to the low level initializes the internal control circuit and registers and puts DOUT in the high level and all data port pins (P00 to P27) into the Hi-Z state.	Input: TTL Schmidt	

Port Output Types and I/O States

The output type and I/O states of the LC709006A's ports can be selected by configuring the data direction register (DDR) and data register (DTR). Port data can be taken into the LC709006A only when DDR is set to 0 (Nch-open drain) and DTR is set to 1 (Nch-Tr OFF). The ports are held high for the other settings of DDR and DTR.

Port Name	DDR	DTR	Port		
			Output Type	Input	Output
P00 to P07 P10 to P17 P20 to P27	0	1	Nch-open drain	Enabled	Hi-Z
	0	0	Nch-open drain	Disabled (High)	Low
	1	1	CMOS	Disabled (High)	High
	1	0	CMOS	Disabled (High)	Low

Port Output Circuit



Principles of Operation

The LC709006A accomplishes data transmission and reception to and from the MCU through synchronous serial communication and performs I/O operations on the extended ports in parallel mode. Its communication modes (MCU to LC709006A by serial to parallel conversion and LC709006A to MCU by parallel to serial conversion) include the initial communication modes (modes 0 and 1) in which the LC709006A initializes itself and the data communication mode in which the LC709006A sends and receives port data. The initial communication modes are used for various communication control purposes for the first time in system operation after a power-on or system reset. In these modes, the LC709006A sets up the I/O mode and output type of the ports. The data communication mode is used for communication control after the end of the initial communication modes. In this mode, the LC709006A carries out actual port I/O operations. The port I/O mode and output type settings are stored in the data direction register (DDR). The data output state settings ("High" output, "Hi-Z" output, or "Low" output) are stored in the data register (DTR). The LC709006A's operating modes are summarized below, followed by detailed mode descriptions.

Communication Mode		Description
Initial communication mode	Mode 0	Sets the output type of all ports to "N-ch-open drain."
	Mode 1	Sets the I/O direction of the ports and their output type to CMOS or "Nch-open-drain" on a bit basis.
Data communication mode		Sends and receives port data.

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(1) Initial communication modes

- Mode 0

- 1) Setting the RES pin to the low level initializes the system, sets the DOUT pin to the high level, and sets the DDR register of all ports to 0 and the DTR register to 1. The output type of the ports is set to Nch-open drain and their I/O state (Nch-Tr=OFF) to the "Hi-Z" (input mode) state.
- 2) When the RES pin is set high (reset) and the CS pin is set and held low for a certain period (Tw1CS), the DDR is fixed at 0. Subsequently, the LC709006A is placed in the data communication mode.

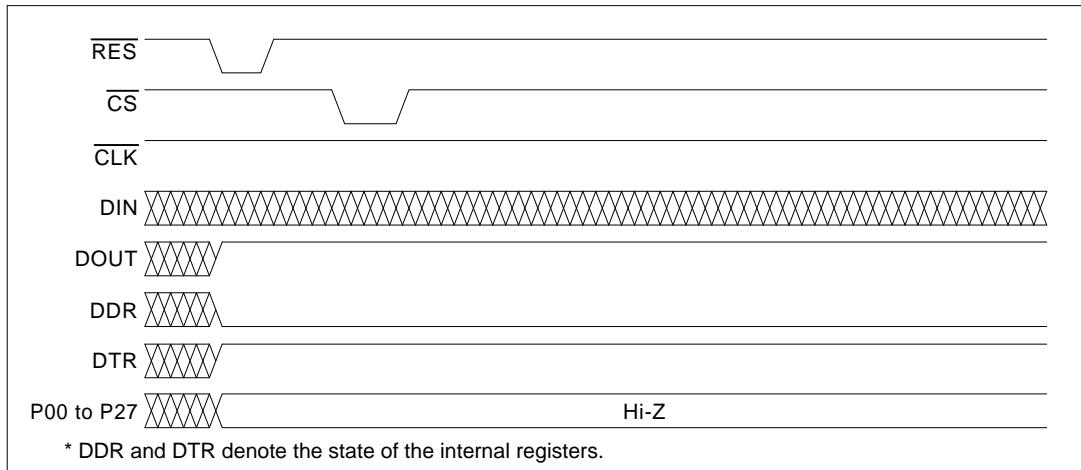


Fig. 1

- Mode 1

- 1) When the RES pin is set to the low level, the LC709006A initializes the system, sets the DOUT pin to the high level, and sets the DDR register of all ports to 0 and the DTR register to 1. The output type of the ports is set to Nch-open drain and their I/O state (Nch-Tr=OFF) to the "Hi-Z" (input mode) state.
- 2) When the RES pins is set high (reset) and the CS pin is set low, the LC709006A gets ready for serial communication.
- 3) The input data at P00 is sent directly to the DOUT pin on the first falling edge of the transmission clock signal CLK. The data at pins P01 to P27 is loaded into the shift register on the rising edge of the next clock.
- 4) Subsequently, the ports' input data, which is loaded into the shift register on the falling edge of CLK, is placed at the DOUT pin sequentially (P00→P07, P20→P27) in synchronization with the falling edges of CLK, starting at port pin P00. In parallel with this operation, when data to be placed at the ports is supplied to the DIN pin sequentially starting at the port pin P00 (P00→P07, P10→P17, P20→P27), it is loaded into the internal shift register in synchronization with the rising edges of CLK.
- 5) When the CS pin is set high after the rising edge of the 24th clock, the data loaded in the shift register is loaded into the DDR register which determines the I/O mode and output type of the data (serial data is loaded into the DDR register after a reset is effected). Subsequently, the LC709006A controls serial data transmission and reception in the data communication mode.

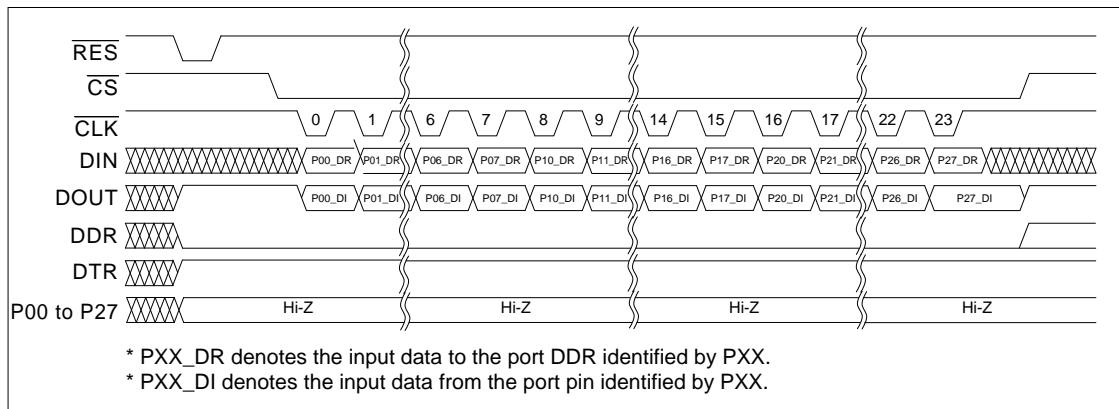


Fig. 2

(2) Data communication mode

- 1) When the CS pin is set low with the RES pin held high, the LC709006A gets ready for serial communication. (Subsequently, processing in steps 2) and 3) are identical to steps 2) and 3) in paragraph (1)-2).
- 2) The input data at P00 is sent directly to the DOUT pin on the first falling edge of the CLK signal. Data at pins P01 to P27 is loaded into the shift register on the next rising edge of the clock.
- 3) Subsequently, the ports' input data, which is loaded into the shift register on the falling edge of CLK, is placed at the DOUT pin sequentially (P00→P07, P10→P17, P20→P27) in synchronization with the falling edges of CLK, starting at port pin P00. In parallel with this operation, when data to be placed at the ports is supplied to the DIN pin sequentially starting at the port pin P00 (P00→P07, P10→P17, P20→P27), it is loaded into the internal shift register in synchronization with the rising edges of CLK.
- 4) When the CS pin is set high after the rising edge of the 24th clock, the data loaded in the shift register is loaded into the DDR register which determines the output state of the ports and the states of all port pins (P00 to P27) are then changed (output) according to the conditions established in the DDR and DTR registers. Serial data that occurs following the initial communication mode processing is always loaded into the DTR register.

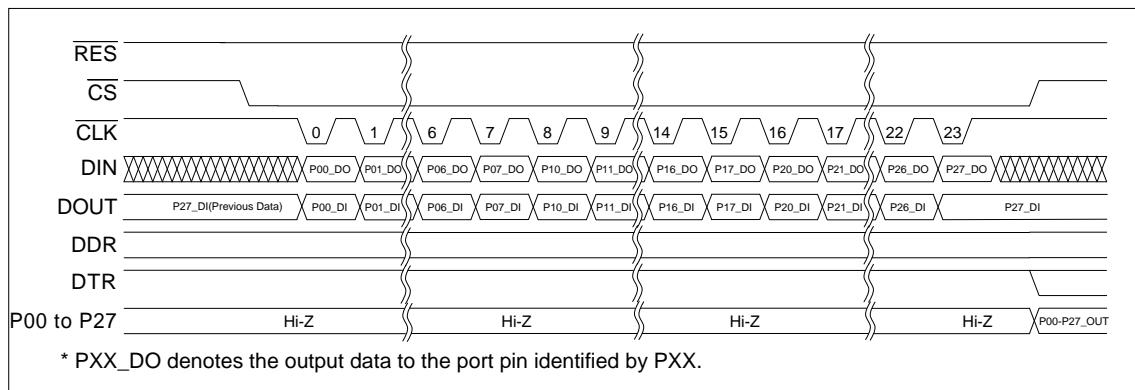


Fig. 3

- 5) Subsequently, the state of all port pins (P00 to P27) is updated each time the set of steps 1) to 4) described in paragraph (2) are performed.

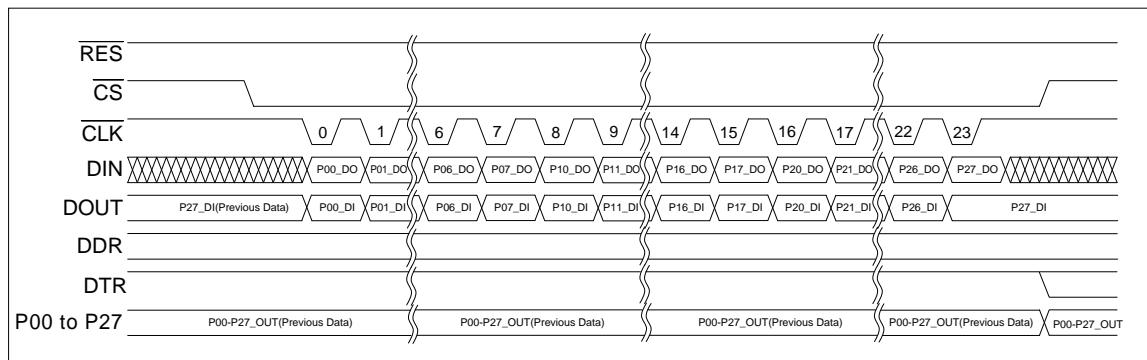


Fig. 4

Note: Connect a Pull-up resistor (about 100kΩ) to CS using MCU VDD.

Application Examples

(1) Example of a cascade configuration

Two or more LC709006A LSI chips can be cascaded to realize port expansion beyond 24 bits. Port expansion, however, need to be made in units of 24 bits \times n (n denotes the number of LSI chips).

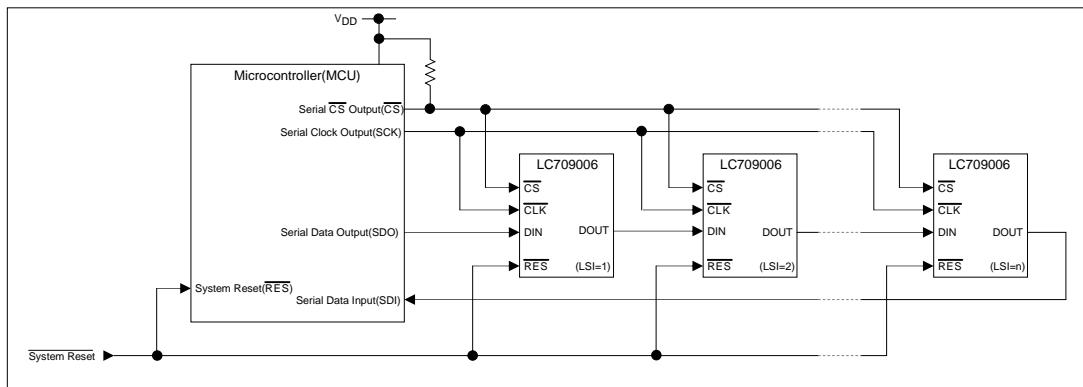


Fig. 5

(2) Variable port power level example

When controlling the level of I/O ports according to the power voltage level of the peripheral equipment, the user can connect the output from the power supply of the peripheral equipment directly to the power supply pins for the I/O ports. The LC709006A dispenses with the need to add an external level shifter circuit.

Note the following when configuring the LC709006A in this way:

Note 5:

- V_{DDP0} : The voltage level of V_{DDP0} must not be higher than that of V_{DD} ($V_{DDP0} \leq V_{DD}$).
- V_{DDP1} : The voltage level of V_{DDP1} must not be lower than that of V_{DD} ($V_{DDP1} \geq V_{DD}$).
- V_{DDP2} : The voltage level of V_{DDP2} must not be lower than that of V_{DD} ($V_{DDP2} \geq V_{DD}$).
- The input level of all ports (P00 to P27) is dependent on the V_{DD} power source; it depends on none of the power sources V_{DDP0} to V_{DDP2} .

* Be sure to check the electrical characteristics of the LC709006A.

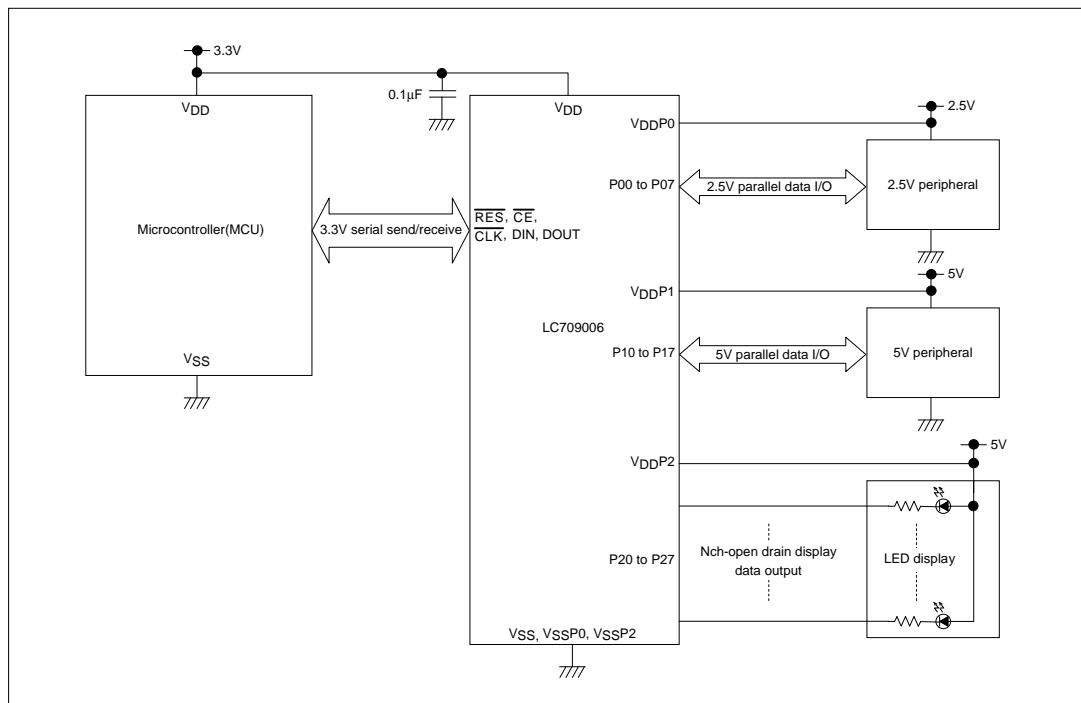


Fig. 6

Example of Placing Bypass Capacitors between V_{DD} and V_{SS} Terminals

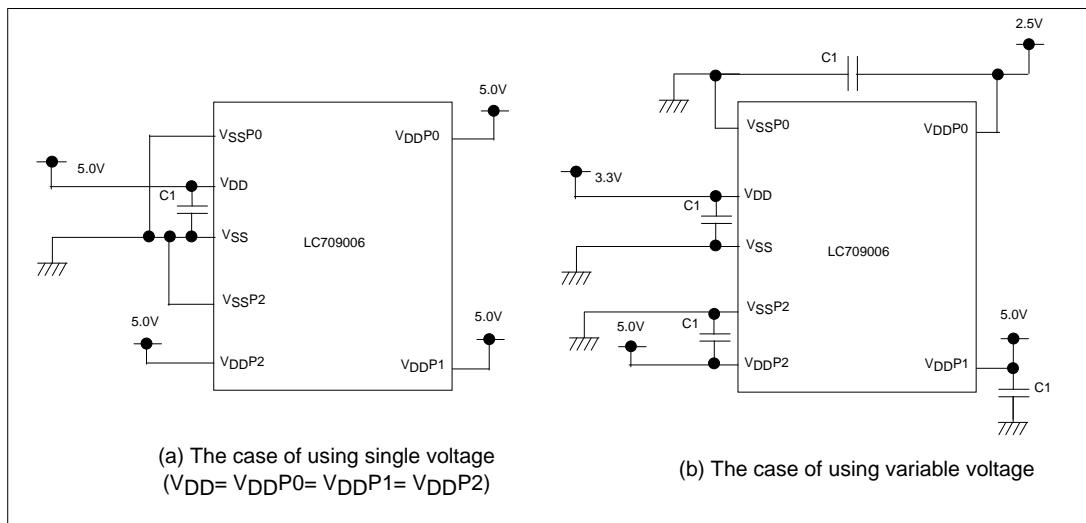


Fig. 7

In the case of using single voltage source as showing in the Fig.7 (a), you must connect a bypass capacitor (C1, about $0.1\mu F$) between V_{DD} and V_{SS}. When connecting the capacitor (C1) and V_{DD}-V_{SS}, use a thick wire, and try to make its length as short as possible: moreover, try to make the impedance of V_{DD}-C1 and V_{SS}-C1 equal.

In addition, when using several voltage sources as showing in the Fig.7 (b), it is suggested to connect the bypass capacitor to each set of the voltage terminals.

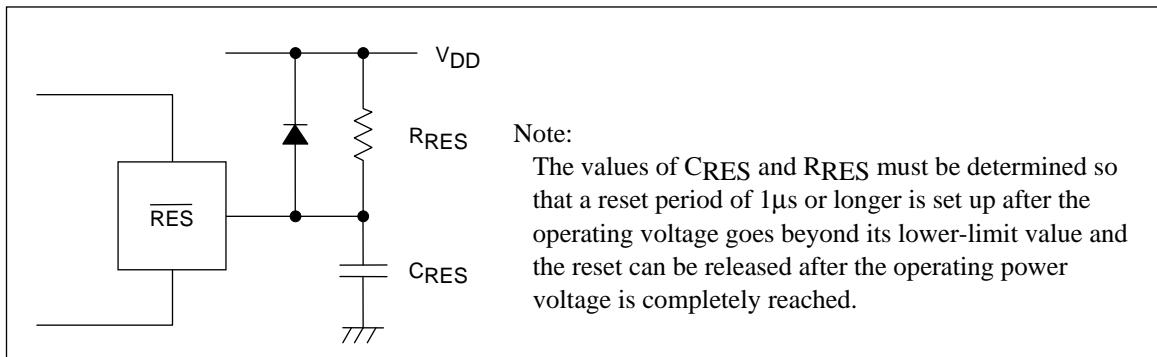


Fig. 8: Reset Circuit

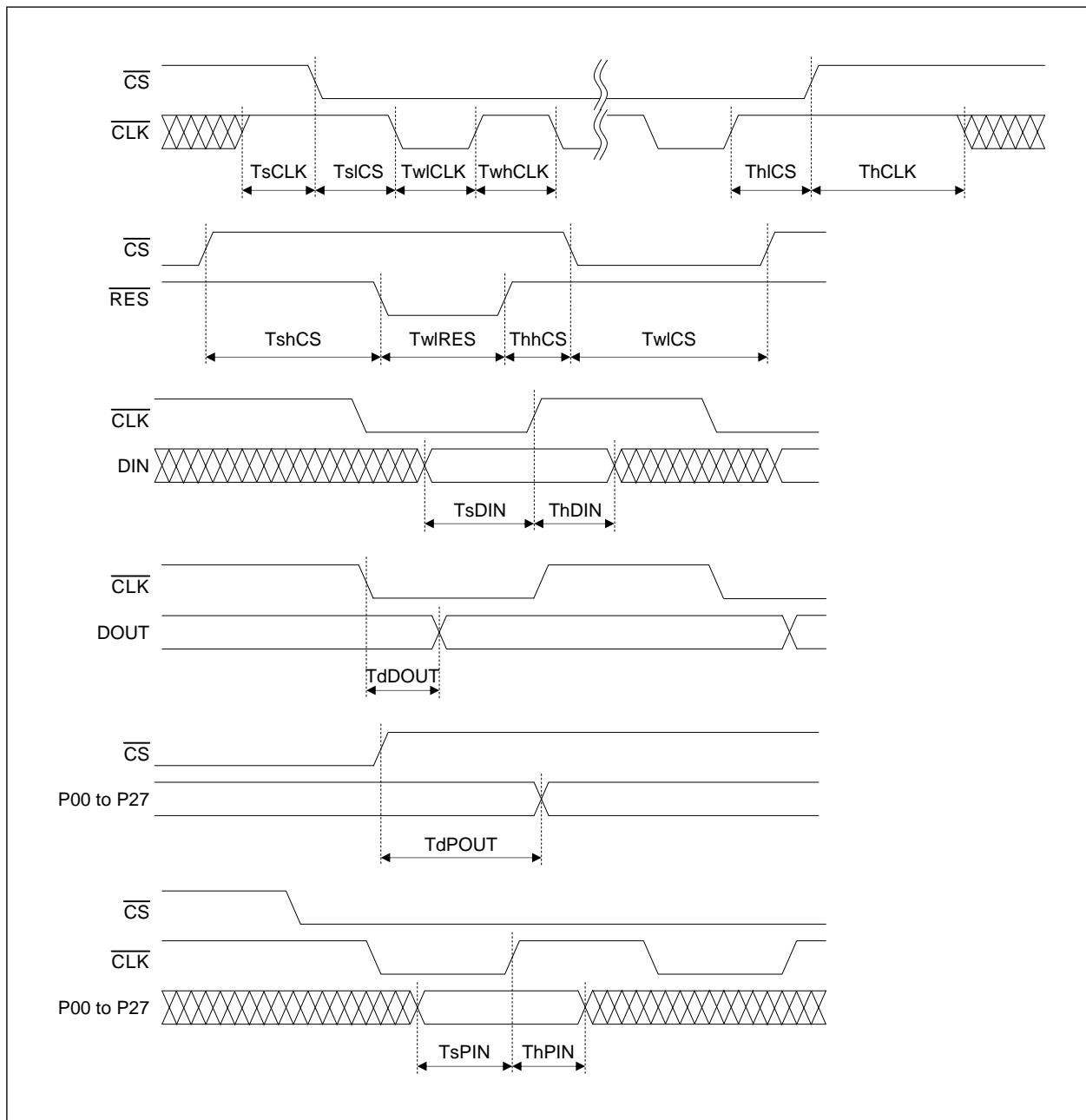


Fig. 9: Serial I/O and Parallel Data I/O Timing Diagram

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